

# 2SC5851

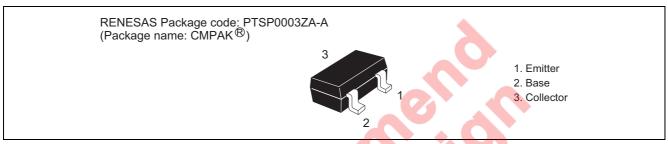
# Silicon NPN Epitaxial

REJ03G0761-0100 (Previous ADE-208-1480) Rev.1.00 Aug.10.2005

#### **Features**

High frequency amplifier

### **Outline**



\*CMPAK is a trademark of Renesas Technology Corp.

# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	30	V
Collector to emitter voltage	V <sub>CEO</sub>	30	V
Emitter to base voltage	V <sub>EBO</sub>	5	V
Collector current	Ic	100	mA
Collector power dissipation	P <sub>C</sub> *	150	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +125	°C

<sup>\*</sup>Value on the glass epoxy board (10 mm x 10 mm x 0.7 mm)

### **Electrical Characteristics**

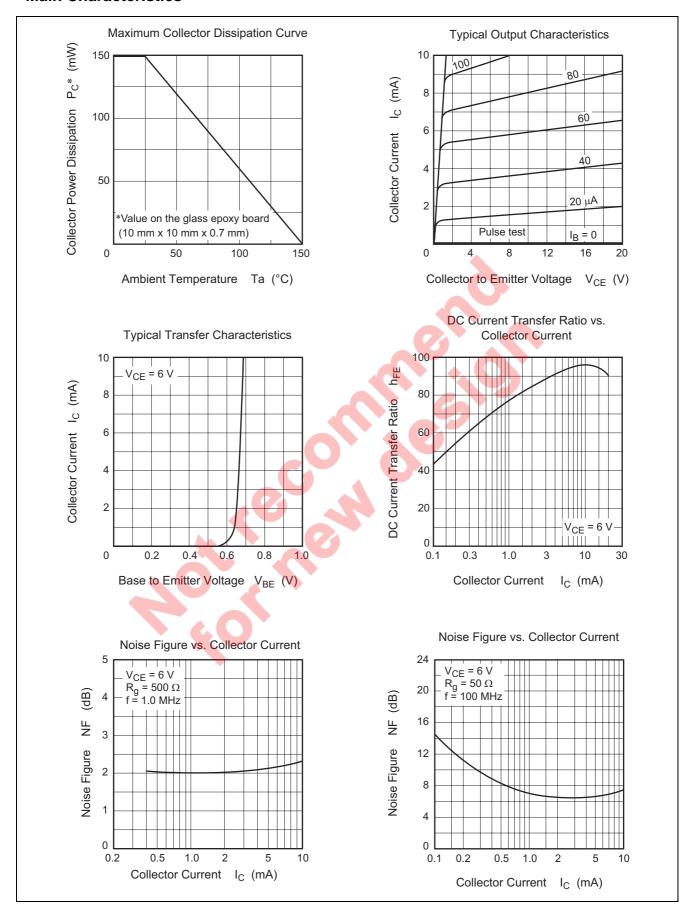
 $(Ta = 25^{\circ}C)$ 

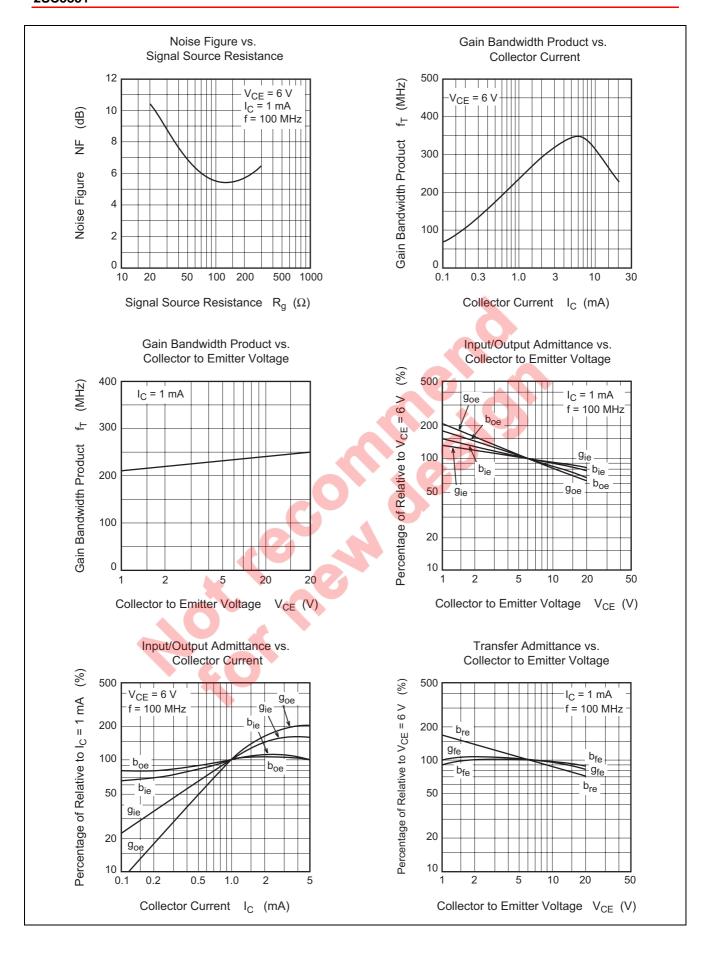
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	_	_	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	30	_	_	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	_	_	V	$I_E = 10 \mu\text{A},  I_C = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	0.5	μΑ	$V_{CB} = 20 \text{ V}, I_{E} = 0$
Emitter cutoff current	I <sub>EBO</sub>	_	_	0.5	μΑ	$V_{EB} = 2 \text{ V}, I_{C} = 0$
DC current transfer ratio	h <sub>FE</sub> *1	35	_	200		$V_{CE} = 12 \text{ V}, I_{C} = 2 \text{ mA}$
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	_	_	1.1	V	$I_C = 10 \text{ mA}, I_B = 1 \text{ mA}$
Base to emitter voltage	$V_{BE}$	_	_	0.75	V	$V_{CE} = 12 \text{ V}, I_{C} = 2 \text{ mA}$
Gain bandwidth product	f⊤	_	230	_	MHz	$V_{CE} = 12 \text{ V}, I_{C} = 2 \text{ mA}$
Collector output capacitance	C <sub>ob</sub>	_	1.6	_	pF	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$
Noise figure	NF	—	5.5	_	dB	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA},$
						f = 100  MHz, Rg = 100 Ω

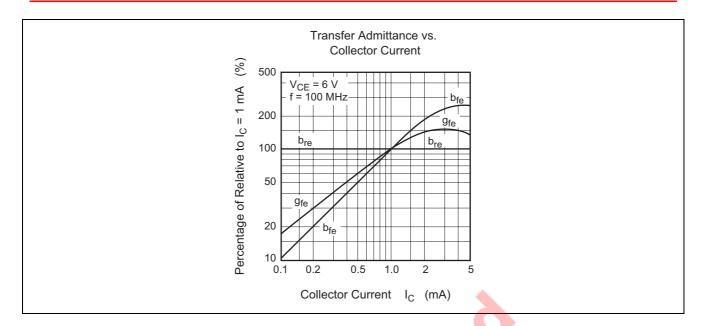
Notes: 1. The 2SC5851 is grouped by hFE as follows.

Grade	Α	В	C
Mark	FA	FB	FC
h <sub>FE</sub>	35 to 75	60 to 120	100 to 200

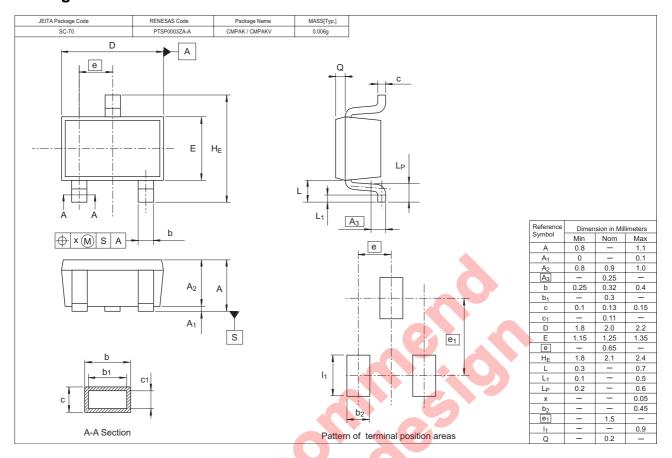
### **Main Characteristics**







## **Package Dimensions**



## **Ordering Information**

Part Name		Quantity	Shipping Container
2SC5851FATL-E	3000		φ 178 mm Reel, 8 mm Emboss Taping
2SC5851FBTL-E	92		
2SC5851FCTL-E			

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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